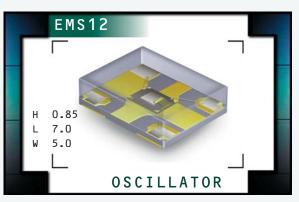
EMS12 Series

- ECLIPTEK® CORPORATION
- Spread Spectrum MEMS Clock Oscillators
- Low EMI LVCMOS Output
- +2.5V Supply Voltage
- Tri-State, Power Down, and Spread Disable Options
- Center Spread and Down Spread Modulation Options
- 4 Pad Plastic SMD Package
- 30,000 G Shock Resistance
- RoHS Compliant (Pb-Free)



ELECTRICAL SPECIFICATIONS

Nominal Frequency				1MHz to 87MHz, 93MH	z to 175MHz	
Operating Temperature Range	perating Temperature Range			-20°C to +70°C, or -40°C to +85°C		
Storage Temperature Range				-55°C to +125°C		
Supply Voltage (V _{DD})				$2.5V_{DC} \pm 10\%$		
Maximum Supply Voltage (V _{DD})				-0.5Vdc to +3.65Vdc	-0.5Vdc to +3.65Vdc	
Input Current	≤ 25.000MHz (Unloaded;	Nominal Vdd)		25mA Maximum		
	> 25.000MHz (Unloaded	; Nominal Vdd)		35mA Maximum		
Frequency Tolerance / Stability	Inclusive of All Condition	ns: Calibration Tolerance	at 25°C , Fre-	±50ppm or ±100ppm Maximum		
	quency Stability over the	Operating Temperature	Range, Supply			
	Voltage Change, Output I	₋oad Change, 1st Year A	ging at 25°C,			
	260°C Reflow, Shock, and	d Vibration				
Output Voltage Logic High (V _{OH})			90% of V _{DD} Minimum			
Output Voltage Logic Low (V _{OL})	$I_{0L} = +8mA$			10% of V _{DD} Maximum		
Rise Time / Fall Time	20% to 80% of waveform			2nSeconds Maximum		
Duty Cycle	\leq 125.000MHz (at 50% o	≤ 125.000MHz (at 50% of waveform)			50 ±5(%)	
	> 125.000MHz (at 50% o	f waveform)		50 ±10(%)		
Load Drive Capability				15pF Maximum		
Output Control Function			Tri-State (High Impedance)			
				Power Down (Logic Lov	v)	
				Spread Disabled (Disab	oled)	
Tri-State Input Voltage			Disabled Output: High Impendance			
(V_{IH} and V_{IL})	Maximum to Disable at Output Control Function of Tri-State					
Power Down Input Voltage	70% of V_{DD} Minimum or No Connection to Enable Ouput, 30% of V_{DD}			Disabled Output: Logic	Low	
(V_{IH} and V_{IL})	Maximum to Disable at Output Control Function of Power Down		of Power Down			
Spread Spectrum Input Voltage	ad Spectrum Input Voltage 70% of V_{DD} Minimum or No Connection to Enable Ouput, 30% of V_{DD}		Ouput, 30% of $V_{\scriptscriptstyle DD}$	Spread Spectrum Output: Disabled		
(V_{IH} and V_{IL})	Maximum to Disable at Output Control Function of Spread Disable					
Standby Current	Pad 1=Ground (at Output Control Function of Power Down)		50μA Maximum			
Disable Current	ble Current Pad 1=Ground (at Output Control Function of Tri-State)		State)	20mA Maximum		
Spread Spectrum	Center Spread not available with Output Control Function of Spread Disable Cycle to Cycle; Spread Spectrum-On; Fo=133.333M, Vdd=2.5Vdc First Year at 25°C			±0.25%, ±0.50%, ±1.00%, -0.50%, -1.00%, or -2.00% 30kHz Min, 32kHz Typ, 35kHz Max 40pSec Maximum ±1ppm Maximum		
Modulation Frequency						
Period Jitter						
Aging						
Start Up Time				10mSec Maximum		
MANUFACTURER CATEGORY	SERIES	PACKAGE	V O L T A G E	CLASS	REV - DA	

PLASTIC

OSCILLATOR

EMS12

ECLIPTEK CORP.

0S6C

2.5V

PART NUMBERING GUIDE

EMS12 C H A - 50.000M TR

FREQUENCY TOLERANCE & STABILITY/ **OPERATING TEMPERATURE RANGE**

C = ±100ppm Maximum over -20°C to +70°C $D = \pm 50$ ppm Maximum over -20°C to +70°C $G = \pm 100$ ppm Maximum over -40°C to +85°C $H = \pm 50$ ppm Maximum over -40°C to +85°C

OUTPUT CONTROL FUNCTION

H = Tri-State (Disabled Output: High Impedance) J = Power Down (Disabled Output: Logic Low)

K = Spread Disable (Spread Spectrum Output: Disabled)

AVAILABLE OPTIONS

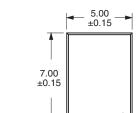
Blank = Bulk TR = Tape & Reel

FREQUENCY

SPREAD SPECTRUM

 $A = \pm 0.25\%$ Center Spread $B = \pm 0.50\%$ Center Spread $C = \pm 1.00\%$ Center Spread D = -0.50% Down Spread E = -1.00% Down Spread F = -2.00% Down Spread

MECHANICAL DIMENSIONS ALL DIMENSIONS IN MILLIMETERS



0.85 .20 ±0.10 (x4) ±0.15 -2.1 0.08 MAX 2 R0.70 ±0.10 5.08 1.70 ±0.10 4 C0.25 ±0.10 1 40 2.60 ±0.15 ±0.10 (x4)

Note A: Center paddle is connected internally to oscillator ground (Pad 2).

SUGGESTED SOLDER PAD LAYOUT







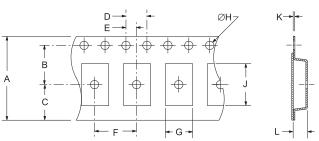
Tolerances= ±0.1

Pad 1: Tri-State or Power Down or Spread Disable

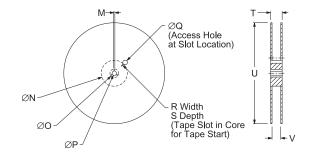
Pad 2: Case Ground Pad 3: Output

Pad 4: Supply Voltage

TAPE AND REEL DIMENSIONS



TAPE	А	В	С	D	E
	16.0 ±0.3	7.5 ±0.2	6.75 ±0.2	4.0 ±0.2	2.0 ±0.2
F	G	Н	J	K	L
8.0 ±0.2	A0*	1.5 ±0.1	B0*	0.30 ±0.05	K0*



REEL	М	N	0	P	Q
	1.5 MIN	50 MIN	20.2 MIN	13.0 ±0.2	40 MIN
R	S	T	U	V	QTY/REEL
2.5 MIN	10 MIN	22.4 MAX	180 MAX	16.4+2/-0	1.000

*Compliant to EIA 481C

REV - DATE

01/10

ENVIRONMENTAL/MECHANICAL SPECIFICATIONS

Characteristic Specification

Solderability

ESD Susceptibility MIL-STD-883, Method 3015, Class 2, HBM: 2000V Flammability Mechanical Shock UL94-V0 MIL-STD-883, Method 2002, Condition G, 30,000G Moisture Resistance MIL-STD-883, Method 1004

Moisture Sensitivity Level J-STD-020, MSL 1 Resistance to Soldering Heat

MIL-STD-202, Method 210, Condition K MIL-STD-202, Method 215

Resistance to Solvents

CATEGORY

MIL-STD-883, Method 2003 (Four I/O Pads on

SERIES

bottom of package only)

MIL-STD-883, Method 1010, Condition B Temperature Cycling MIL-STD-883, Method 1011, Condition B MIL-STD-883, Method 2007, Condition A, 20G

Thermal Shock Vibration MANUFACTURER PACKAGE

800-ECLIPTEK www.ecliptek.com for latest revision

MARKING SPECIFICATIONS

Line 1: XXXX

VOLTAGE

2.5V

Ecliptek Manufacturing Lot Code

CLASS

0560